

APPROVAL SHEET

Customer Name : _____
Customer P/N : _____
Frequency : 8.000000 MHz
Aker Approved P/N : SMAF-008000-3-AL-00
Aker MPN : SMAF-008000-3-AL-00
Rev. : 1
ISSUE DATE : Aug.25.2022

APPROVED	CHECKED	PREPARED
		
APPROVED BY CUSTOMER		

AKER TECHNOLOGY CO., LTD.

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MSL:Level 1

RoHS Compliant

IATF 16949 Certified

AEC-Q200 Qualified



Confidential

[illegible]

SMD CRYSTAL OSCILLATOR

1. ELECTRICAL CHARACTERISTICS

■ Standard atmospheric conditions

Unless otherwise specified , the standard range of atmospheric conditions for making measurement and tests are as follow :

Ambient temperature : $25 \pm 5^{\circ}\text{C}$

Relative humidity : 40%~70%

If there is any doubt about the results , measurement shall be made within the following limits :

Ambient temperature : $25 \pm 3^{\circ}\text{C}$

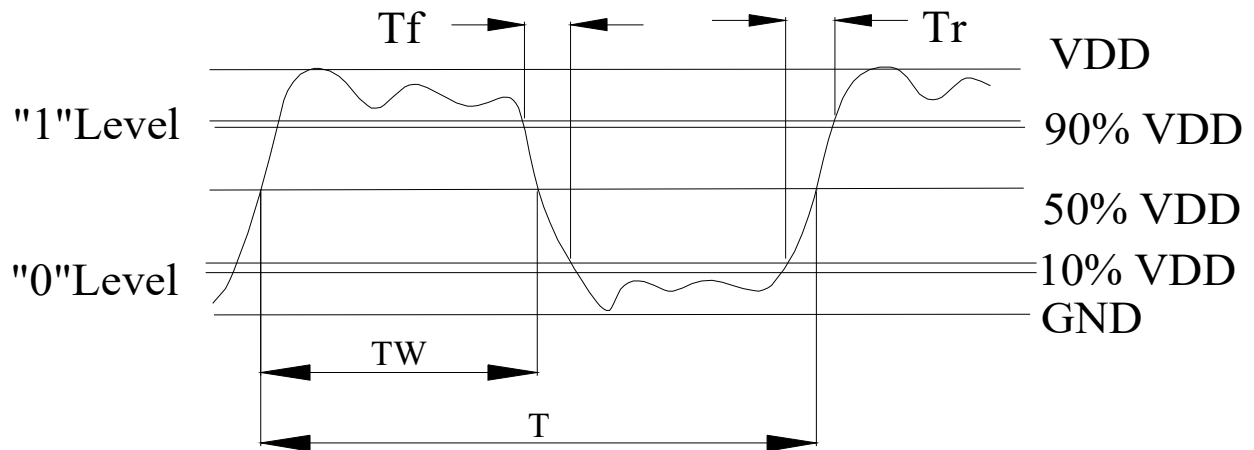
Relative humidity : 40%~70%

■ AKER Model : SMAF-321

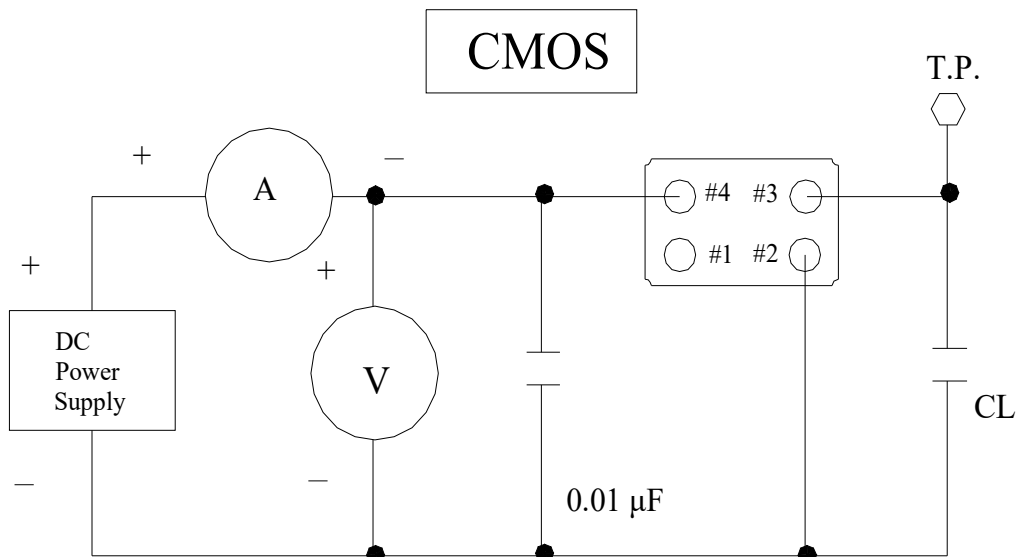
■ Cutting Mode : AT CUT

Parameters	Symbol	Electrical Spec				Notes
		Min.	Typ.	Max.	Units.	
Nominal Frequency		8.000000			MHz	
Frequency Stability		± 50			ppm	
Supply Voltage	V _{CC}	$3.3 \pm 10\%$			V	
Output Load CMOS	CL			15	pF	
Aging		± 3			ppm	First Year
Enable Control		Yes				Pad 1
Operating Temperature		-40	25	85	$^{\circ}\text{C}$	
Storage Temperature Range		-55	~	150	$^{\circ}\text{C}$	
Output Voltage High	VoH	$90\%V_{DD}$			V	
Output Voltage Low	VoL			$10\%V_{DD}$	V	
Input Current	I _{cc}			7	mA	
Standby Current	I _{ST}			10	μA	
Rise Time	Tr			5	ns	10%~90%V _{DD} Level
Fall Time	Tf			5	ns	90%~10%V _{DD} Level
Symmetry (Duty ratio)	TH/T	45	~	55	%	
Start-up Time	T _{osc}			10	ms	
Enable Voltage High	V _{hi}	$70\%V_{DD}$			V	
Disable Voltage Low	V _{lo}			$30\%V_{DD}$	V	
Output Enable Delay Time	T _{on}			10	ms	
Output Disable Delay Time	T _{off}			200	ns	

2 . C - MOS LOAD OUTPUT WAVEFORM

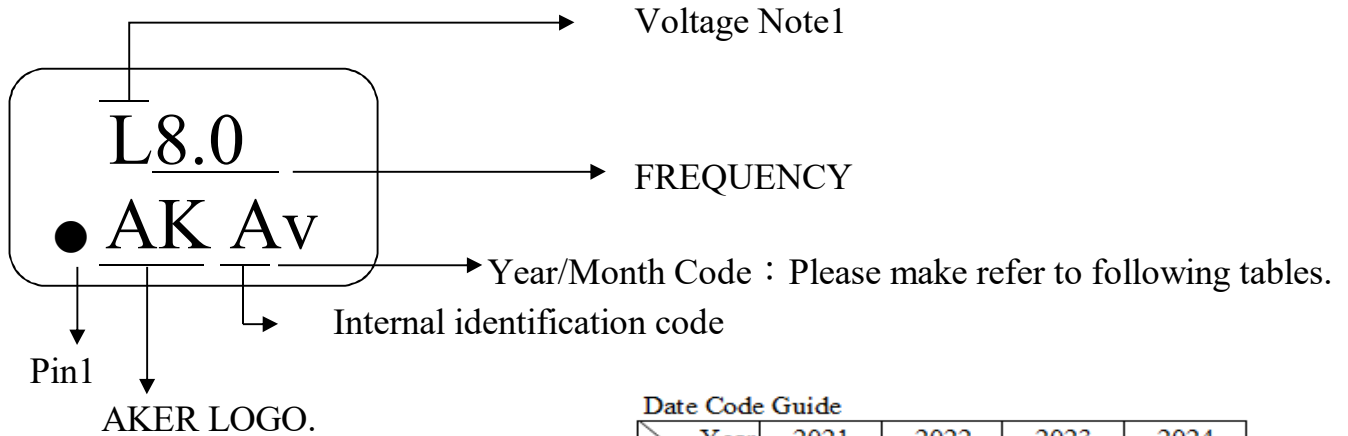


3 . C - MOS LOAD TEST CIRCUIT



***Because SMA series has no by pass capacitor.
So,we recommend our customer to use capacitor 0.01 μF
in join Vcc and GND.

4. MARKING :



NOTE1:

T	5.0V TTL
C	4.5~5.0V CMOS
L	2.97~3.63V TTL&CMOS
R	2.8~3.0V CMOS
S	2.25~2.75V CMOS
Y	1.5~2.0V CMOS
Z	0.8~1.4V CMOS
W	Voltage Range CMOS

Date Code Guide

Year	2021	2022	2023	2024
	2025	2026	2027	2028
Month	(4N+1)	(4N+2)	(4N+3)	(4N+0)
JAN	a	n	A	N
FEB	b	p	B	P
Mar	c	q	C	Q
Apr	d	r	D	R
May	e	s	E	S
Jun	f	t	F	T
Jul	g	u	G	U
Aug	h	v	H	V
Sep	j	w	J	W
Oct	k	x	K	X
Nov	l	y	L	Y
Dec	m	z	M	Z

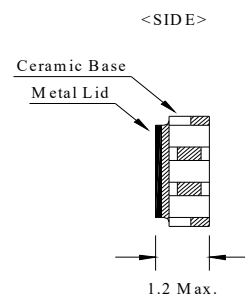
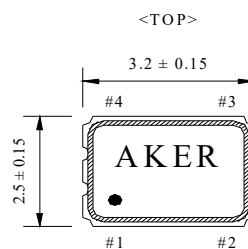
A cycle every four years

5. DIMENSION :

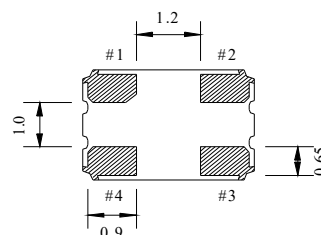
(UNIT : mm)

Enable / Disable Function

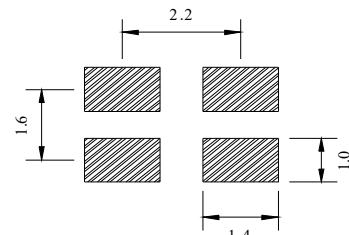
E/D (#1)	OUTPUT (#3)
HIGH (Open)	Operating
LOW	High impedance



<BOTTOM>



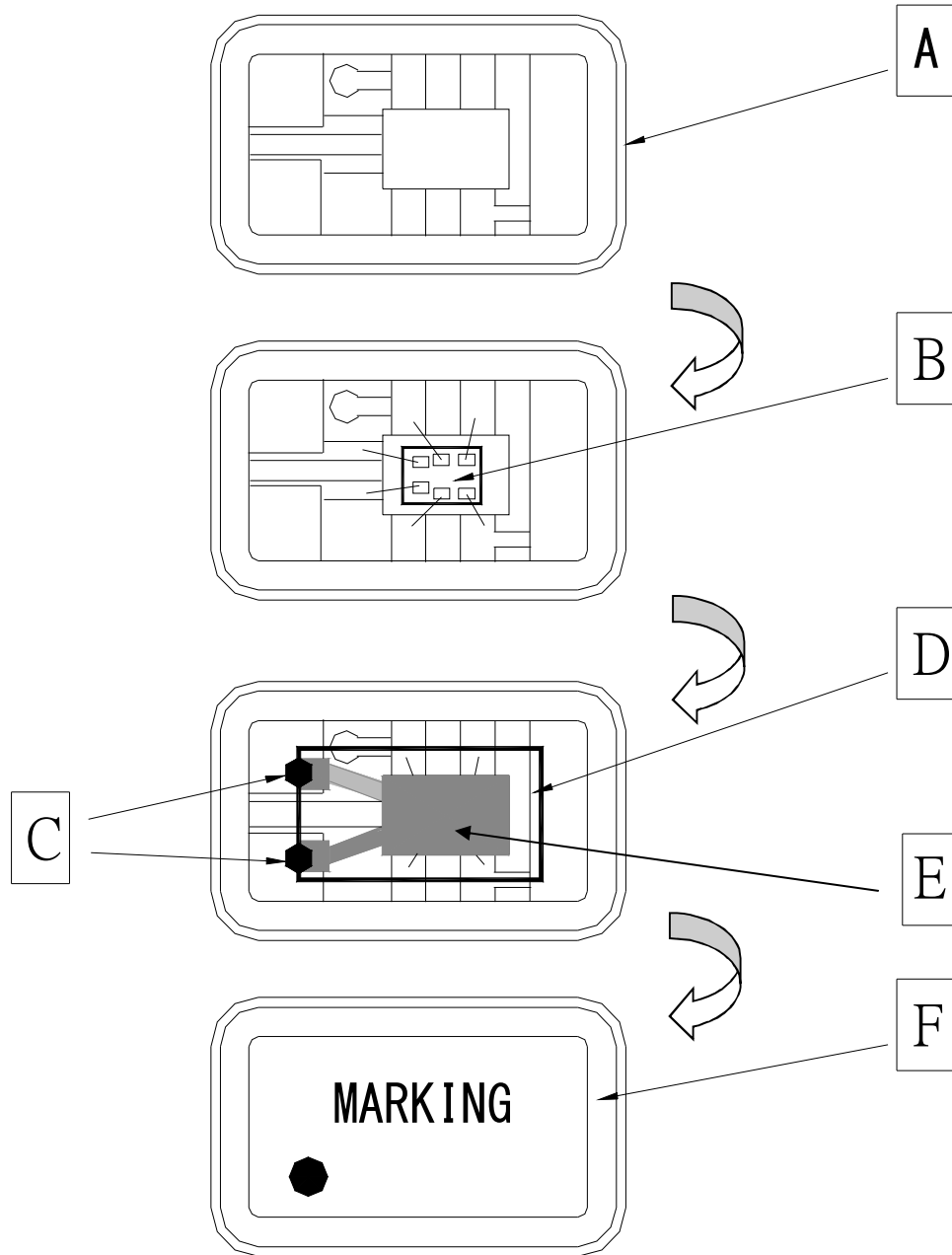
<SUGGESTED LAYOUT>



PIN FUNCTION

- #1 : Enable / Disable Control
- #2 : GND
- #3 : OUTPUT
- #4 : VDD

6 . STRUCTURE ILLUSTRATION

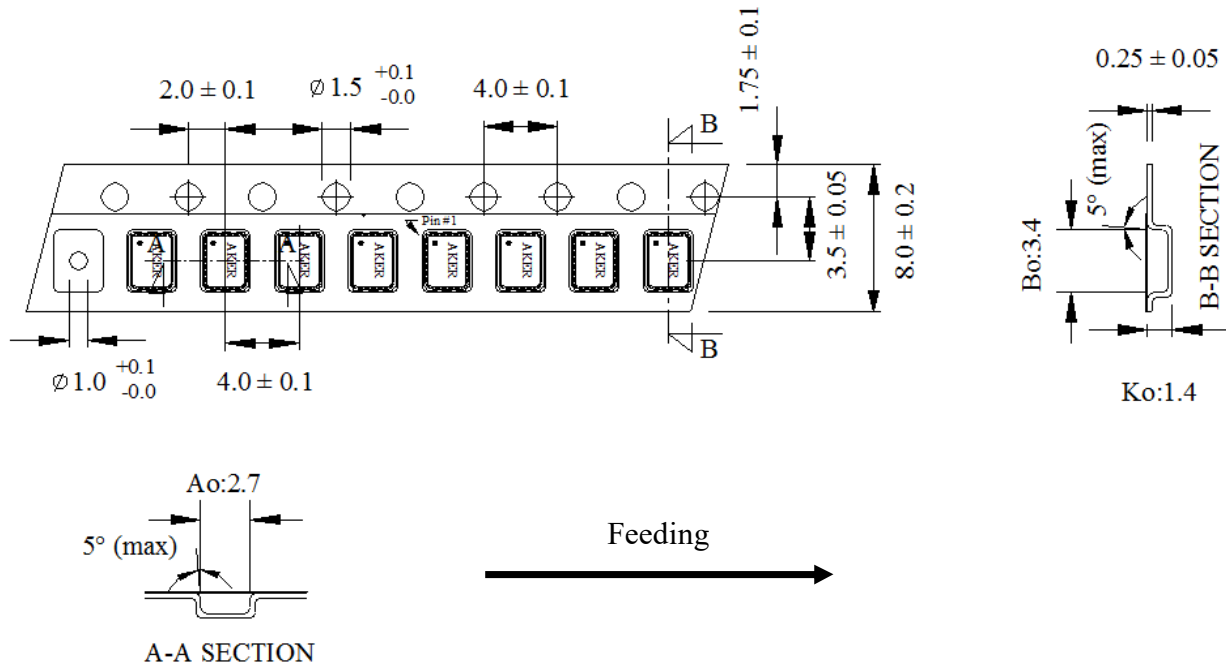


COMPONENTS		MATERIALS	COMPONENTS		MATERIALS
A	Base (Package)	Ceramic (Al ₂ O ₃)+Kovar (Fe/Co/Ni)	D	Crystal blank	SiO ₂
B	IC chip	-	E	Electrode	Cr / Ag
C	Conductive adhesive	Ag / Silicon resin	F	Lid	Fe/Co/Ni

7. PACKING :

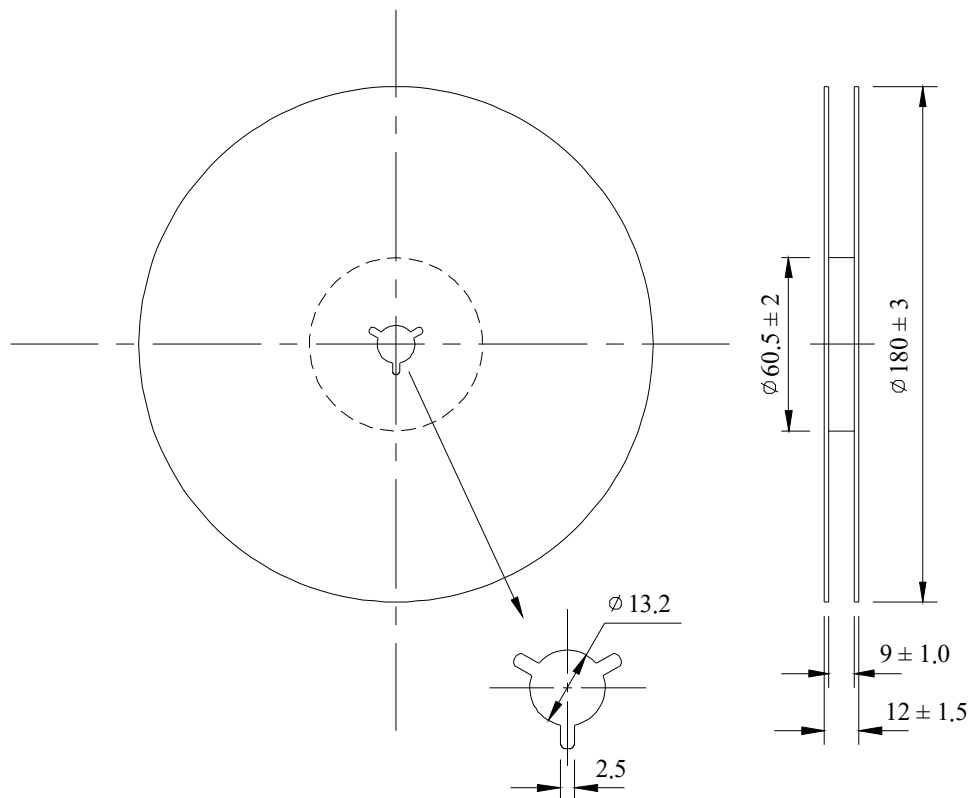
TAPE SPECIFICATION

(Unit : mm)

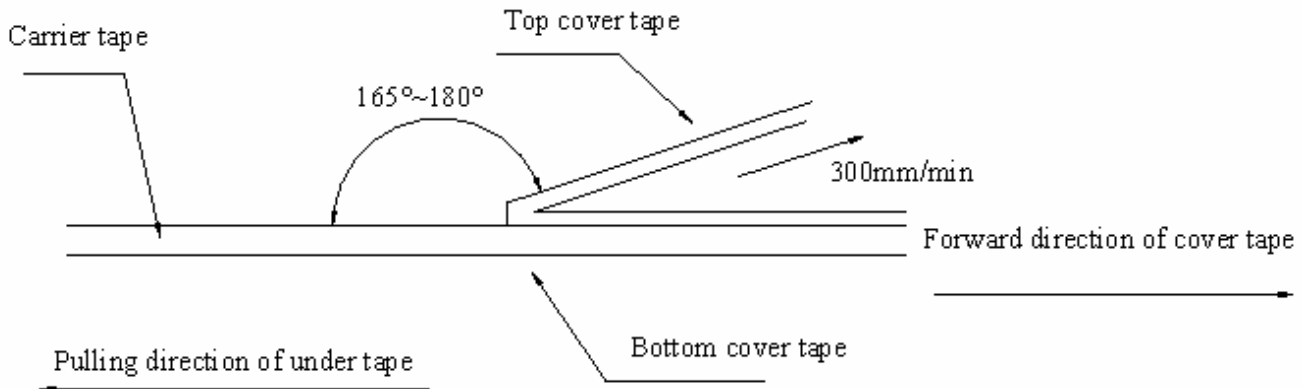


OUTLINE DIMENSION

(Unit : mm)



8. COVER TAPE ADHESION STRENGTH :

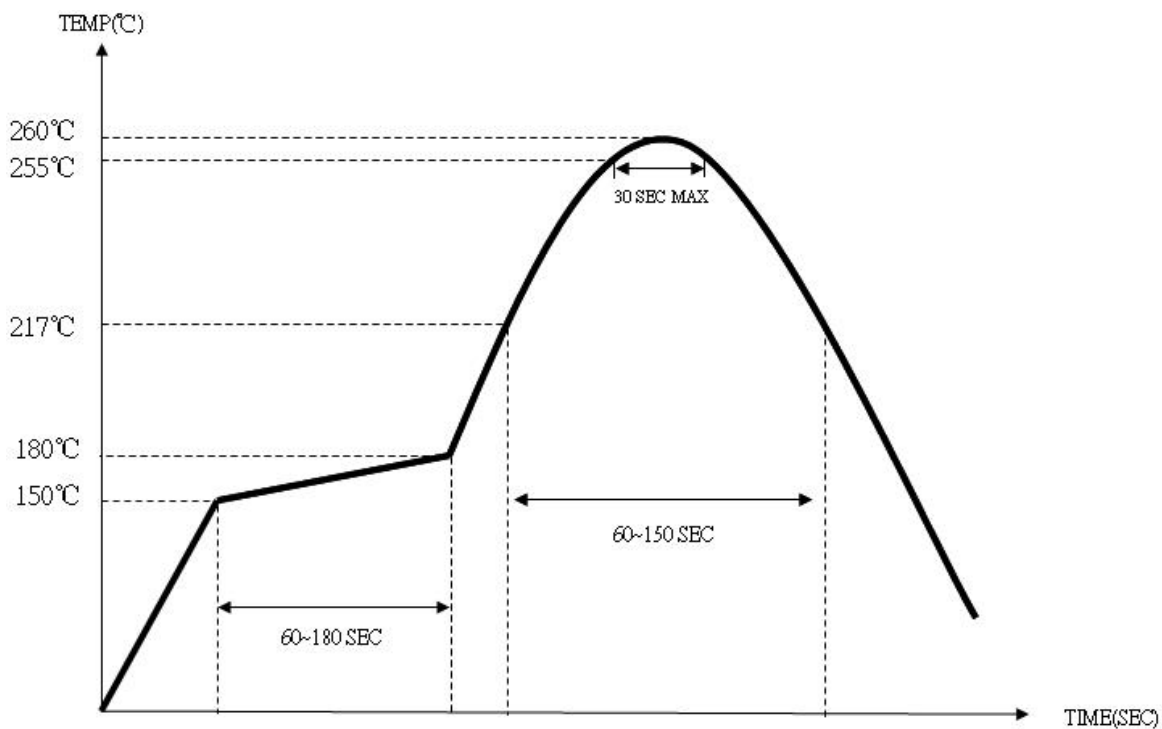


*** In the case, the cover tape is pulled off under the above conditions, the cover tape adhesion strength should be 10.2g~71.4g

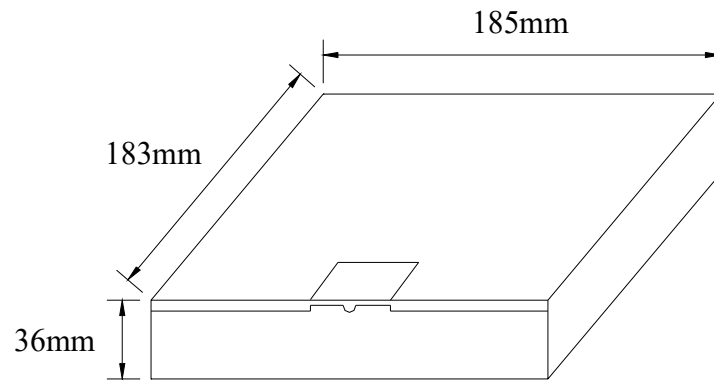
Plastic tape: 10.2g~71.4g

(Cover tape adhesion strength)

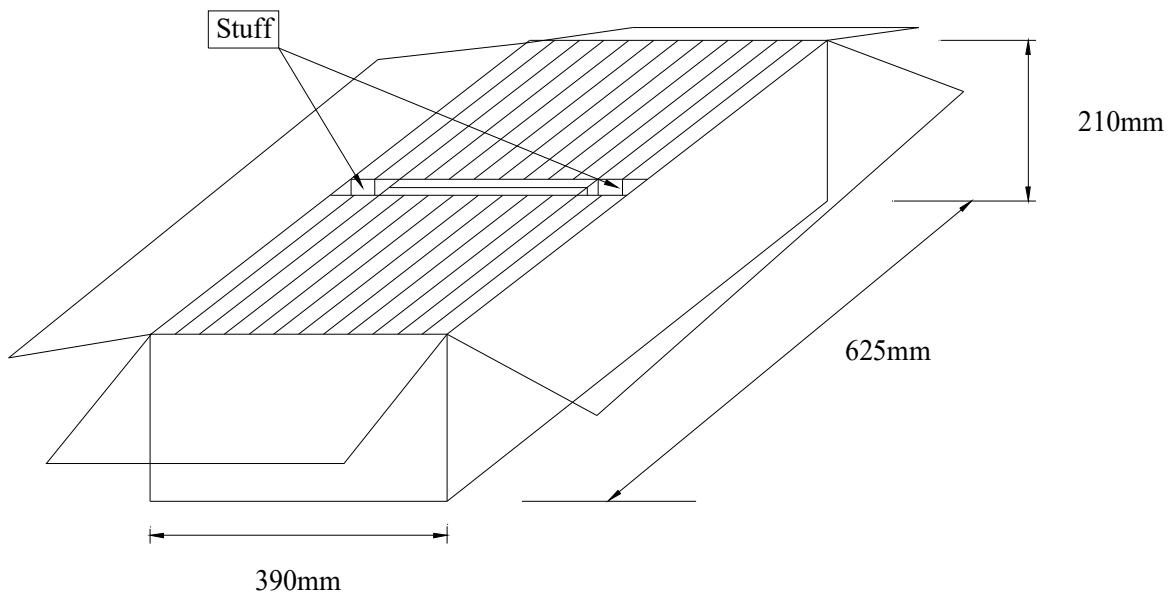
9. SOLDERING REFLOW PROFILE



10. PACKING :



BOX = 3000 PCS / REEL(MAX)



SMD product packs 32 BOX=The outside box packs (3000 PCS * 32 BOX = 96000 PCS)(MAX)

11 . MECHANICAL PERFORMANCE

TEST ITEMS	TEST METHODS AND TEST CONDITION	PERFORMANCE
11.1 Temperature Cycling	-55±3℃/30min maximum~+125±3℃/30min maximum , 1000cycles	To satisfy the electrical performance .
11.2 Operational Life	125℃±3℃ , 1000hrs±12hrs	
11.3 Biased Humidity	85℃±5℃&85%±5%R.H. , 1000±12hrs	
11.4 Resistance To Soldering Heat Test	Reflow test 2 times.	
11.5 High Temperature Exposure	150℃±3℃ , 1000hrs±12hrs	
11.6 Vibration Test	Freq.range: 10~2000Hz , Peak to peak amplitude:1.52mm Peak acceleration:5G (49m/s ²) , 3 direction(X, Y,Z) , 20min 12cycles each of 3 orientations.	
11.7 Mechanical Shock	100G , 6mS , 3 times for each direction(X, Y, Z) , 3 cycles	
11.8 Physical Dimension	Verify physical dimensions to the applicable device detail specification.	
11.9 Solderability	260℃ , Coated > 95%	
11.10 Board Flex	PCB=100*40(mm) , Bending=2 mm (min) , Duration=60+5/-0 sec	
11.11 External Visual	Inspect device construction and marking.	
11.12 Terminal Strength	A force of 17.7N for 60 seconds.	